

ParaFEM: A massively parallel alternative to Abaqus/Ansys for implicit solid mechanics

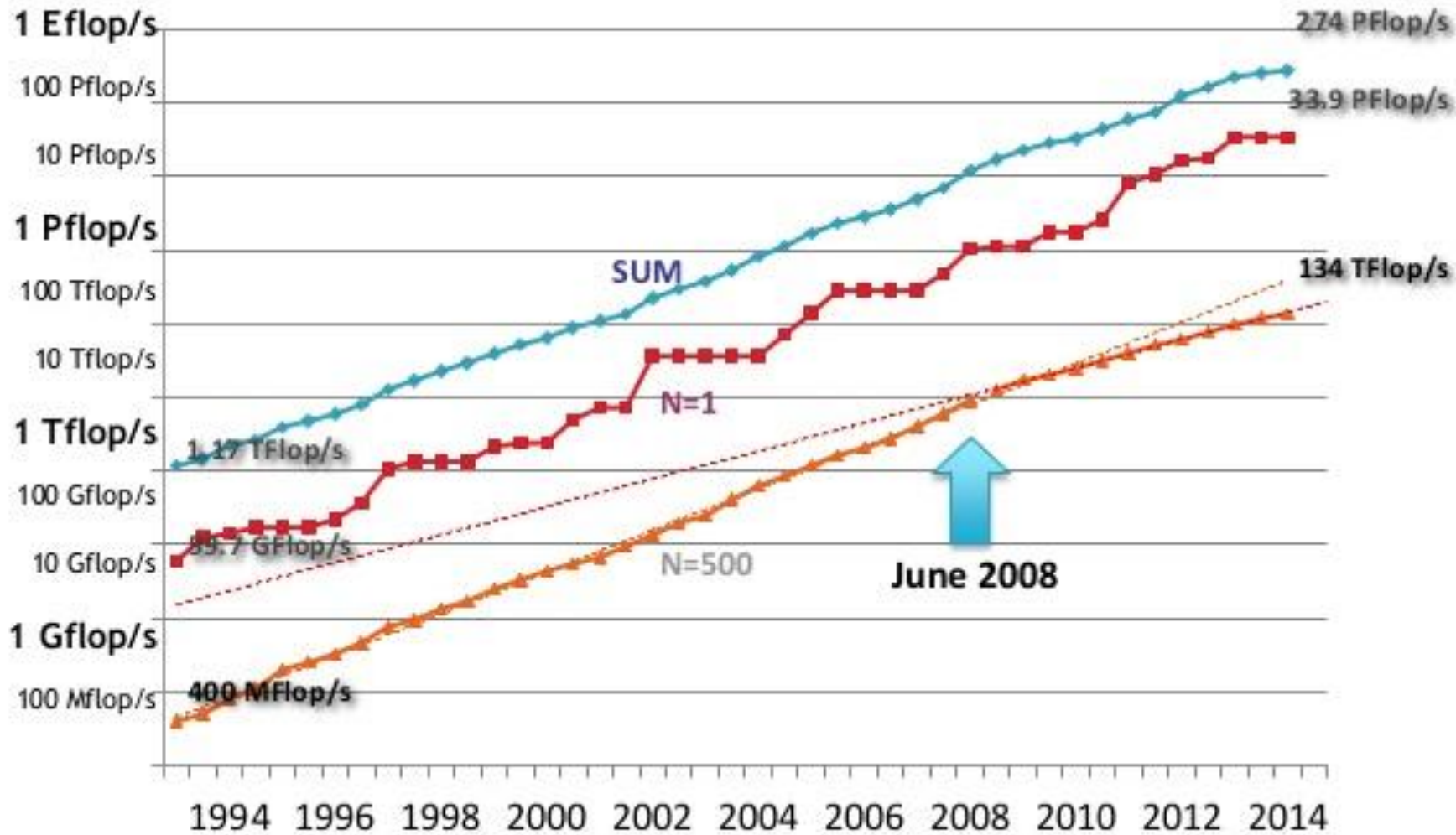
Dr Lee Margetts

School of Mechanical, Aerospace and Civil Engineering

<http://parafem.org.uk>

Advances in Hardware

Performance Development



A wide-angle photograph of a server room. The room is filled with rows of server racks. In the foreground, there are several rows of black server racks with blue panels. Above the racks, there are long, silver, cylindrical pipes running horizontally. The floor is made of light-colored tiles. The ceiling has many recessed lights. The room extends far into the background, showing more racks and pipes.

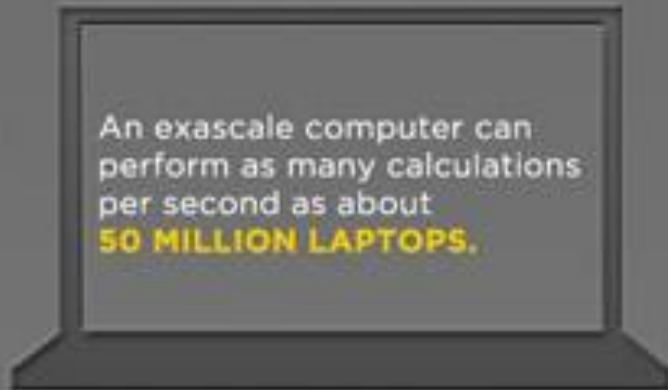
Titan, Oak Ridge National Laboratory

20+ Petaflops

299,008 cores (Opteron) and 18,600 NVIDIA GPUs
>20,000,000,000,000,000 floating point operations per second

1,000,000,000,000,000,000

AN **EXASCALE** COMPUTER WILL PERFORM **ONE QUINTILLION OPERATIONS PER SECOND.**



An exascale computer can perform as many calculations per second as about **50 MILLION LAPTOPS.**



Current projections for power consumption of exascale computers is put at **100 MEGAWATTS** - the same amount of power as **ONE MILLION 100-WATT** lightbulbs.

AN EXASCALE COMPUTER WILL BE

1,000 TIMES FASTER

than today's most powerful supercomputer: **FUJITSU'S K COMPUTER.**

Today's fastest supercomputers are **GIGANTIC** requiring space the size of a football field.

2018?

Scientists hope to build an exascale computer by 2018 with the **Europe, China, Japan and the U.S.** all investing hundreds of millions of \$\$\$.

The processing power will transform sciences such as **astrophysics and biology** as well as improving **climate modelling and national security.**



Evolution
of
Tomb Raider

Larreks

<http://larreks.deviantart.com/art/Evolution-of-Tomb-Raider-425582963>

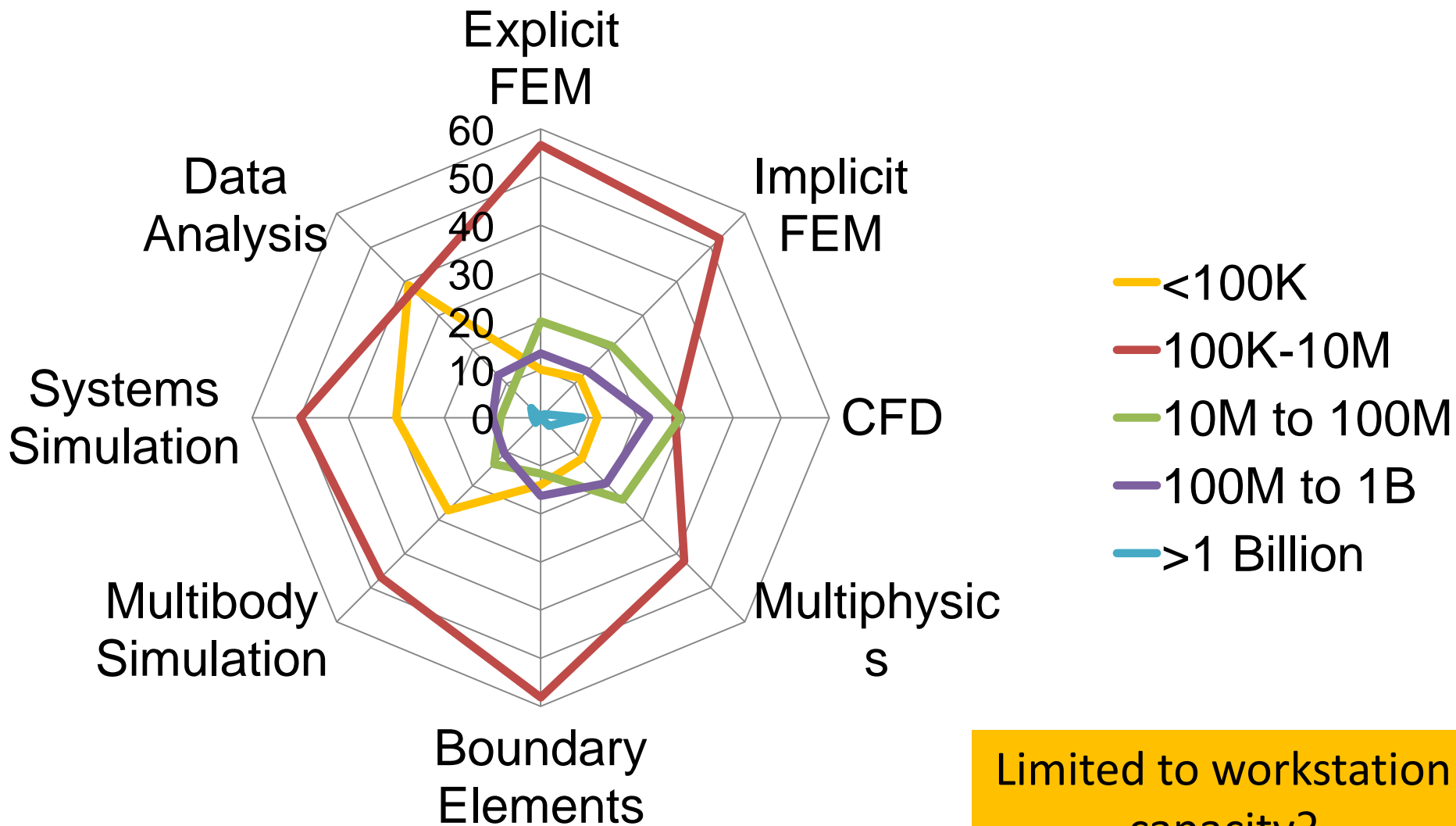
#1 in 1996?



A8 Processor SoC
~172GFlops?

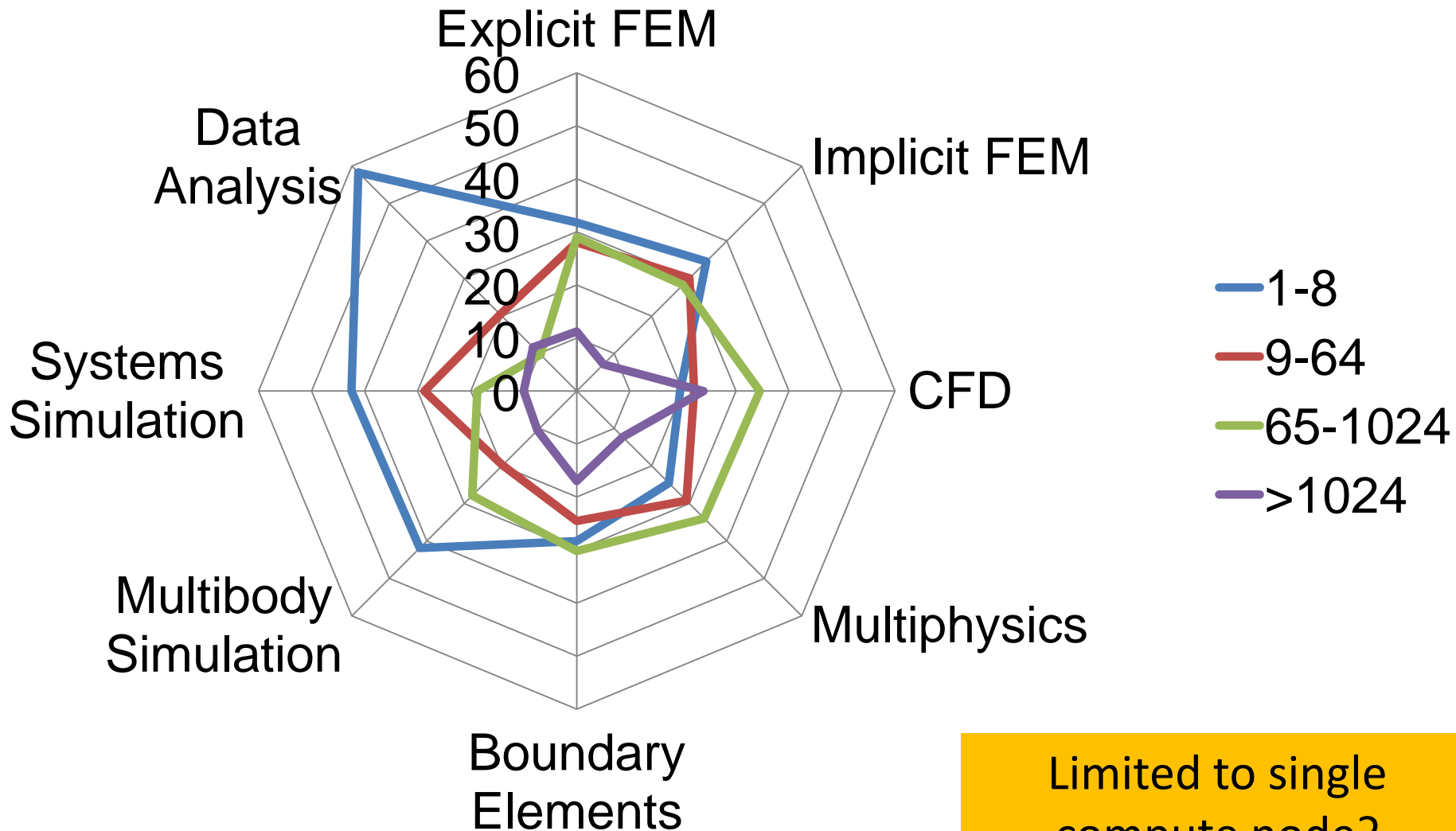
Engineering Simulation

NAFEMS Survey 2014 – Problem Size



Limited to workstation capacity?

NAFEMS Survey 2014 – Number of Cores



Limited to single compute node?

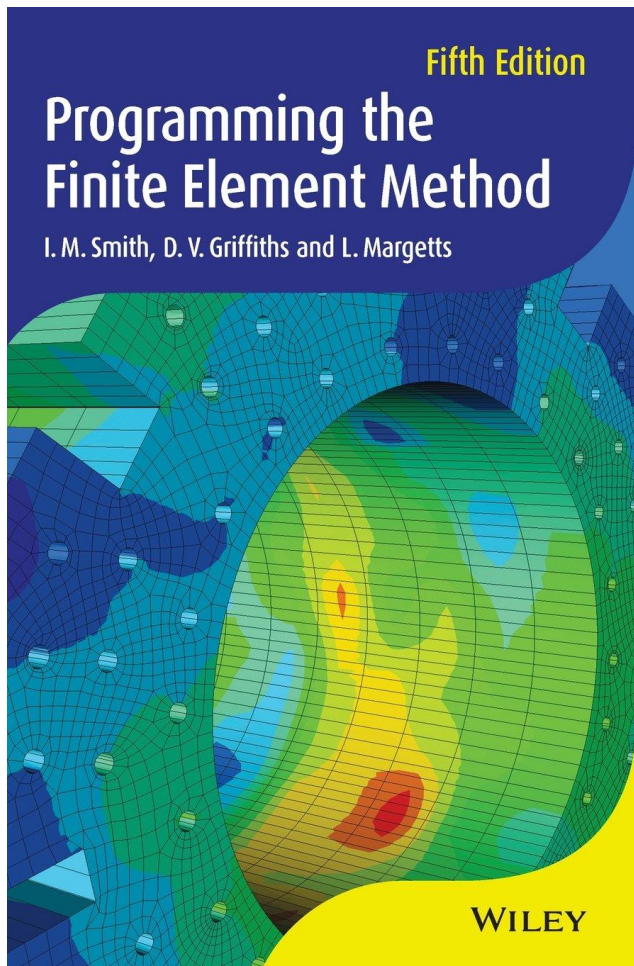
Large 3D finite element problems

Mesh Subdivision	Number of Equations
10 x 10 x 10	12,580
20 x 20 x 20	98,360
40 x 40 x 40	777,520
80 x 80 x 80	6,182,240
100 x 100 x 100	12,059,800
400 x 400 x 400	768,959,200
440 x 440 x 440	1,023,368,720



Tomography $4000 \times 4000 \times 4000$ voxels = 10^{11} to 10^{12} dof

ParaFEM – General Purpose Parallel FE

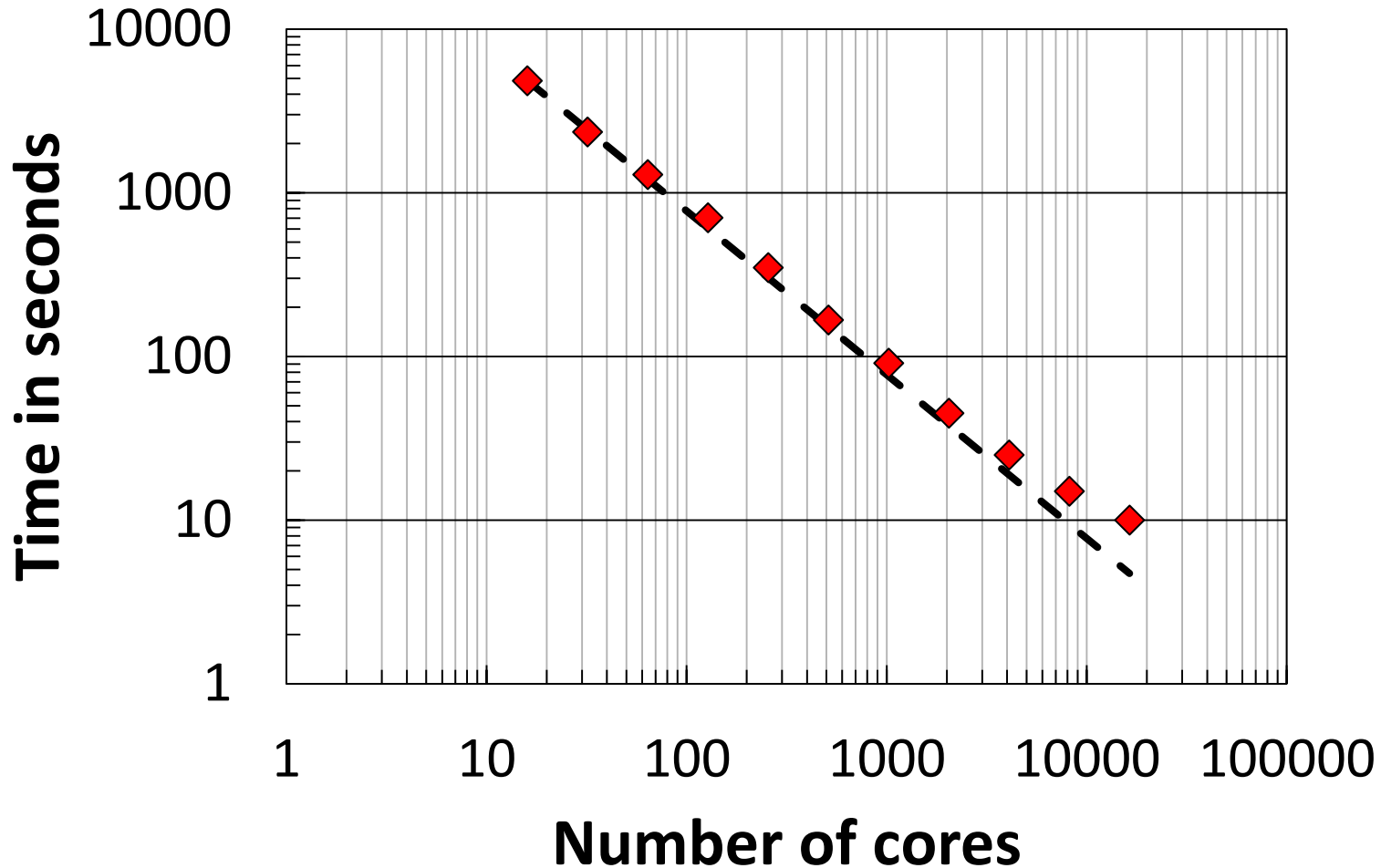


- Fortran + MPI
- Open source engineering package
- ~64,000 cores
- >1 billion degrees of freedom
- Similar functionality to Ansys, Abaqus
- Used for teaching and research
- 750+ registered on website
- ~1000 citations of text book
- <http://parafem.org.uk>
- <http://www.amazon.com/Programming-Finite-Element-Method-Smith/dp/1119973341>

Time for one solution step - elasto-plasticity

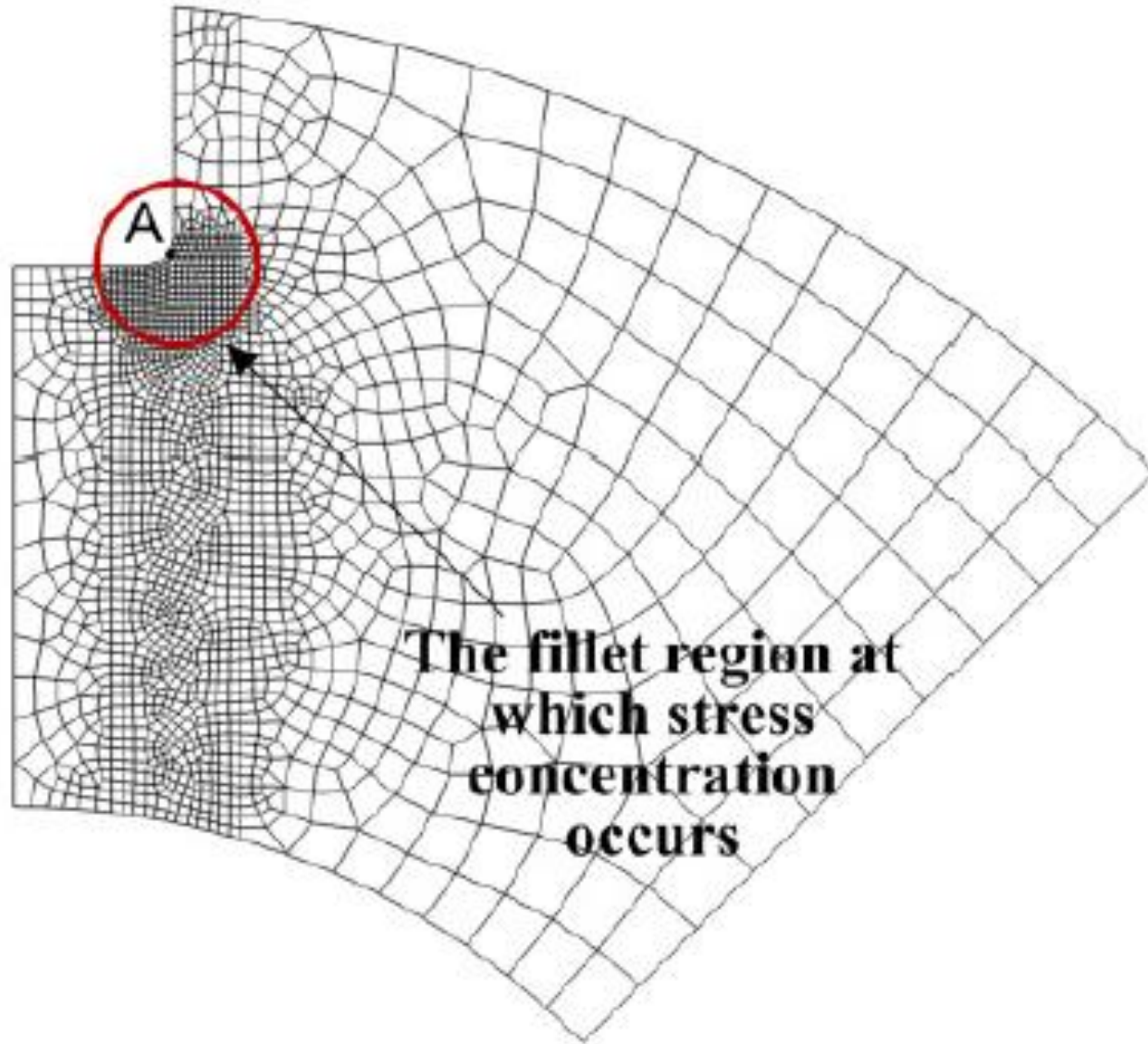
Mesh (equations)	Processes	Time (secs)
12,059,800	16	486
	32	256
	64	140
	128	83
768,959,200	1024	2721
	2048	1213
	4096	662

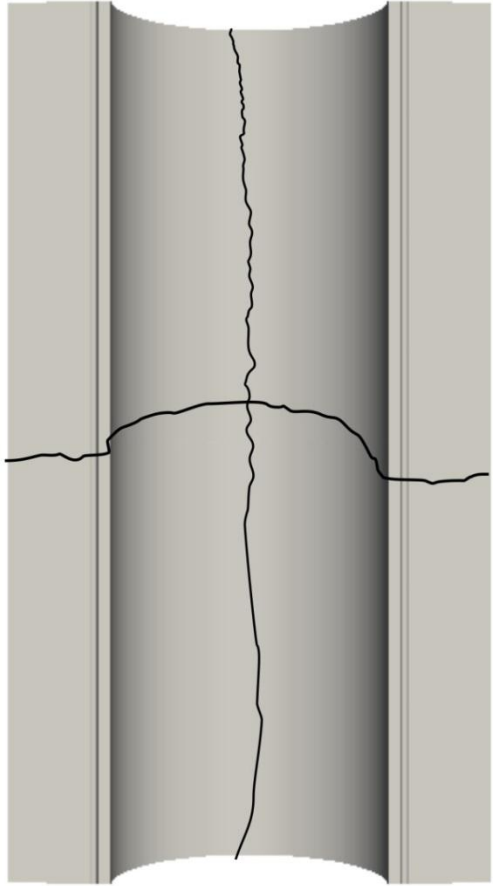
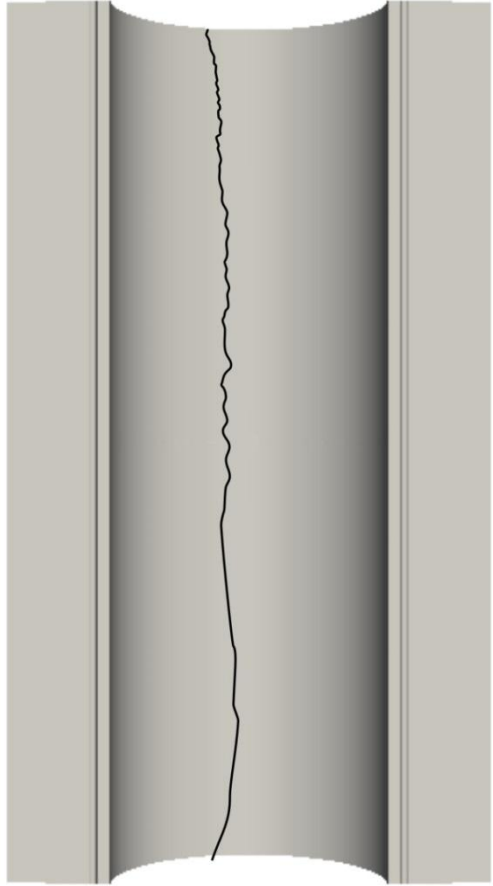
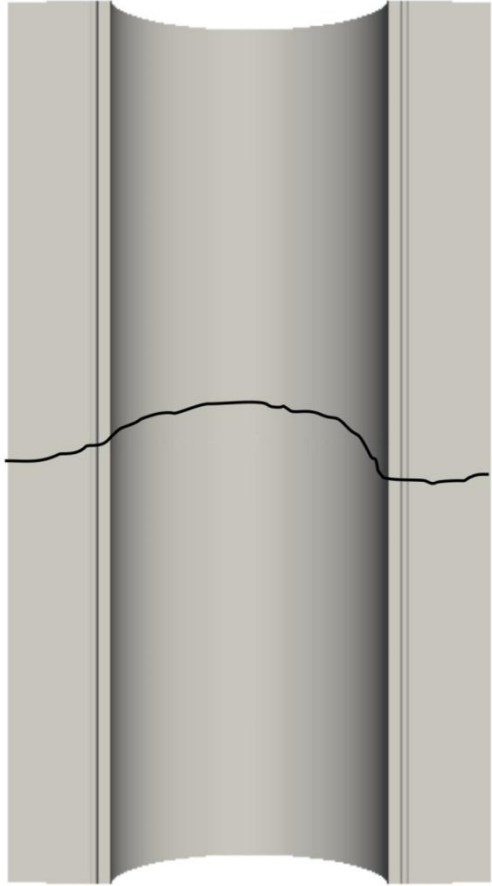
Time for one solution step – transient thermal

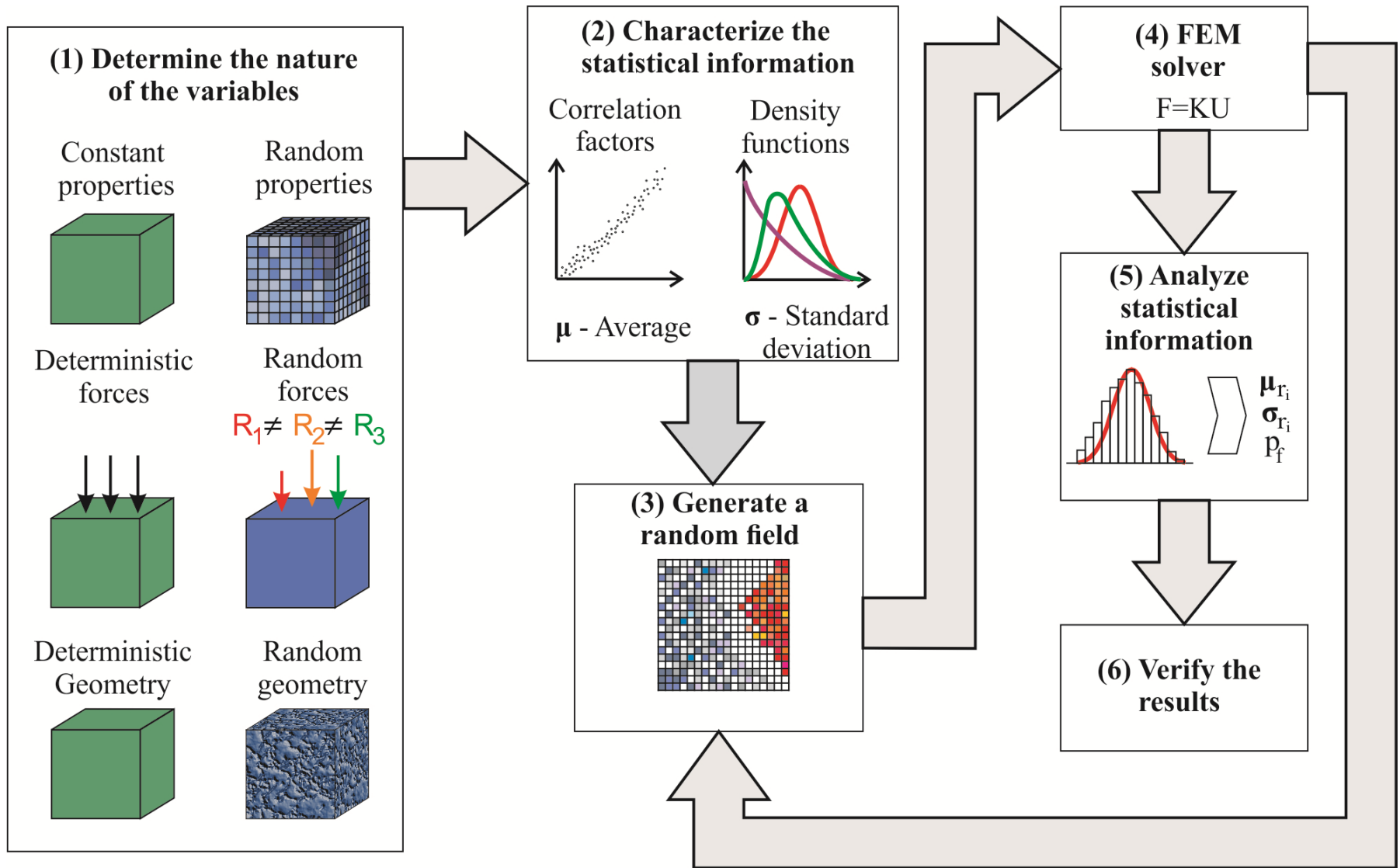


Monte Carlo Simulation

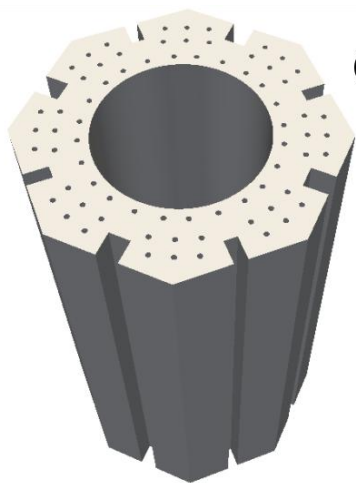








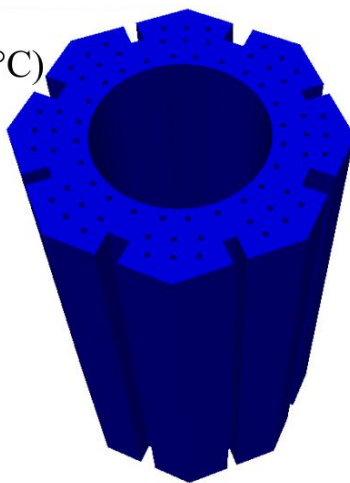
Deterministic



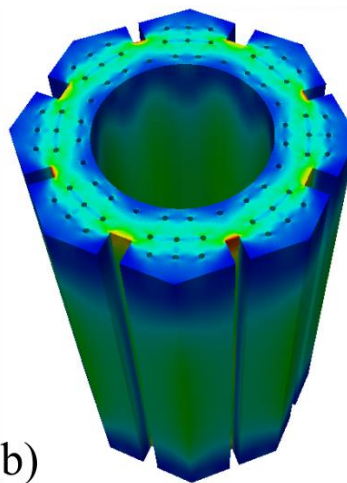
CTE
(mm/mm°C)
4.35E-6



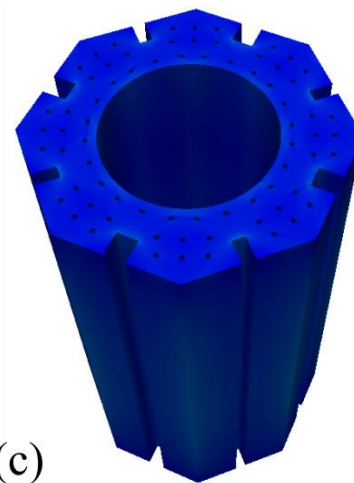
(a)



(b)



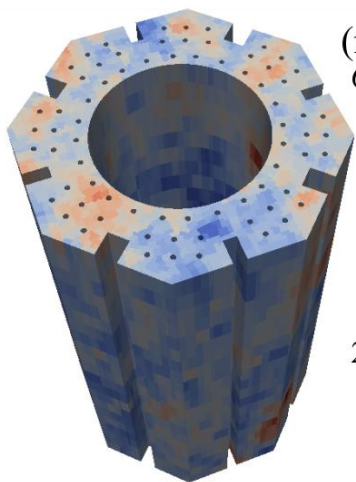
(c)



Von Mises
Stress (MPa)
4.5
4
3
2
1
0

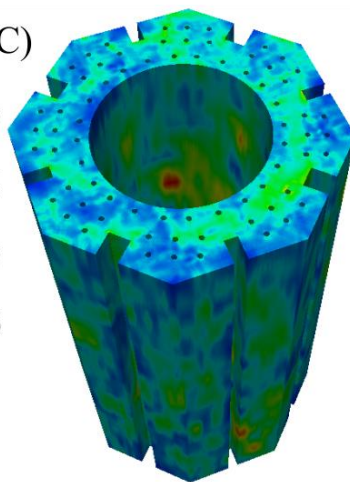
(d)

Stochastic

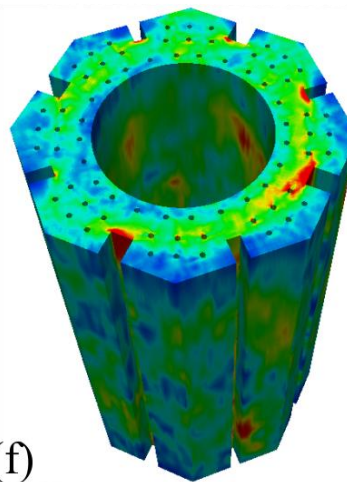


CTE
(mm/mm°C)
6.32E-6
6.00E-6
5.00E-6
4.00E-6
3.00E-6
2.94E-6

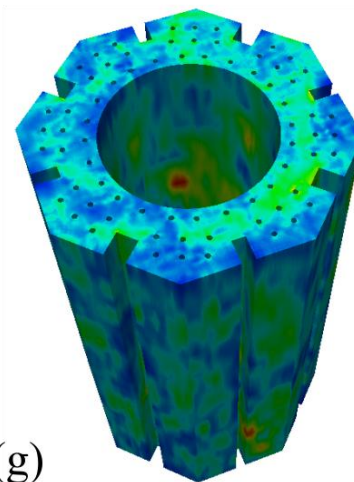
(e)



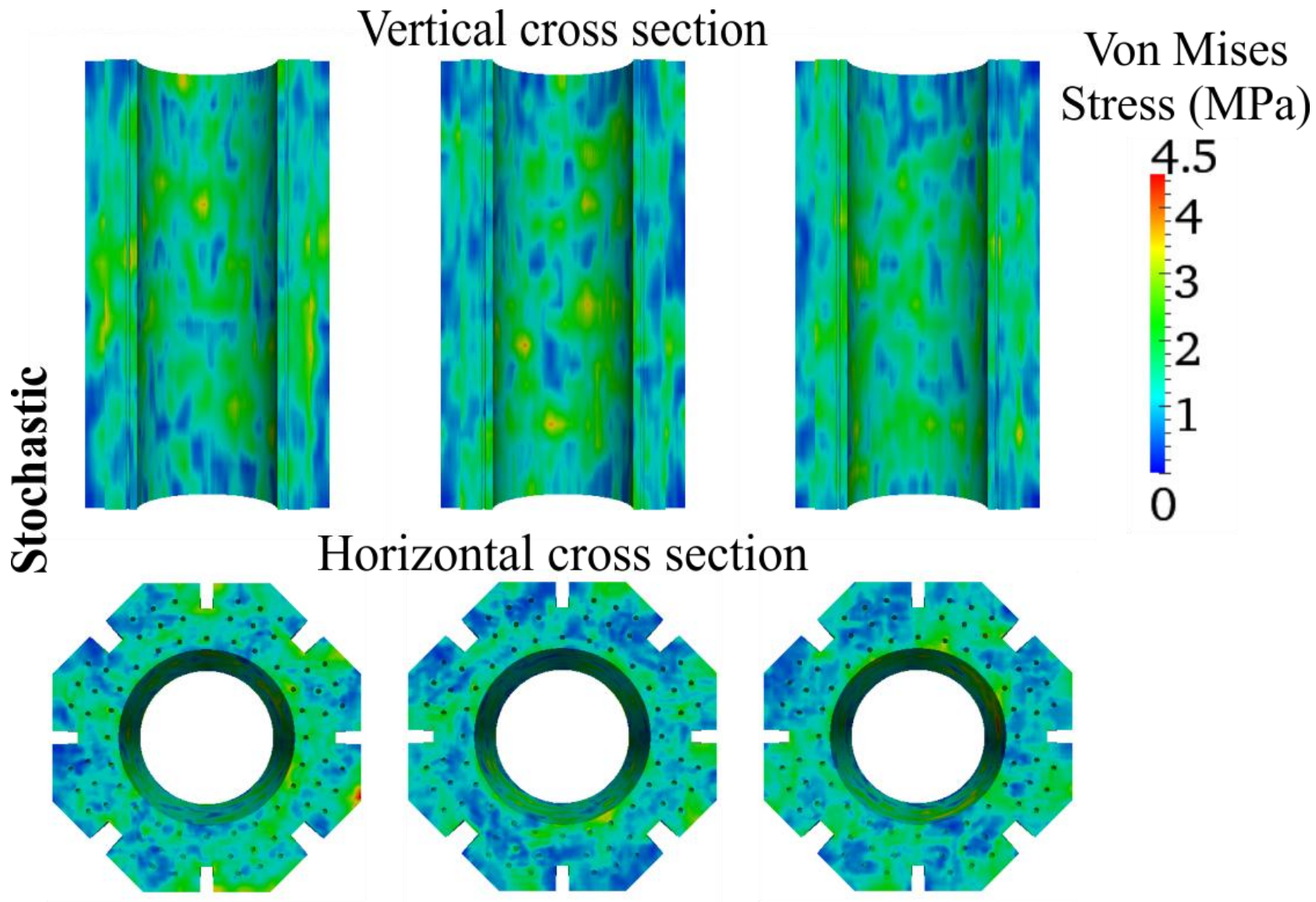
(f)



(g)



(h)

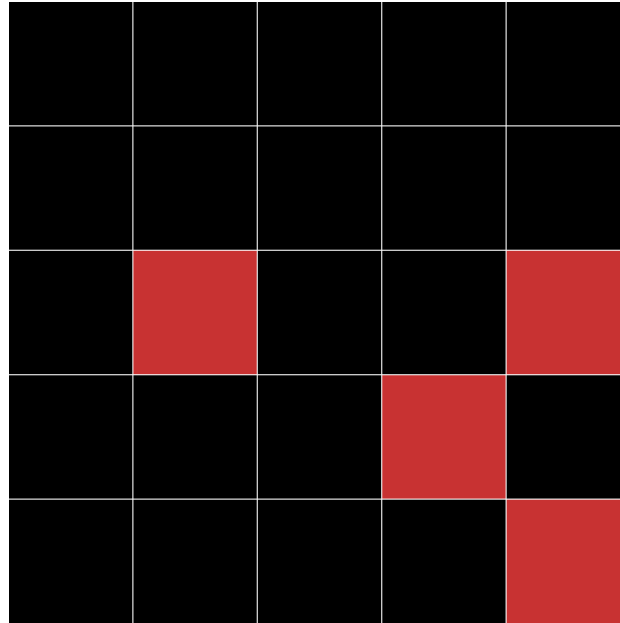


Multi-scale Simulation

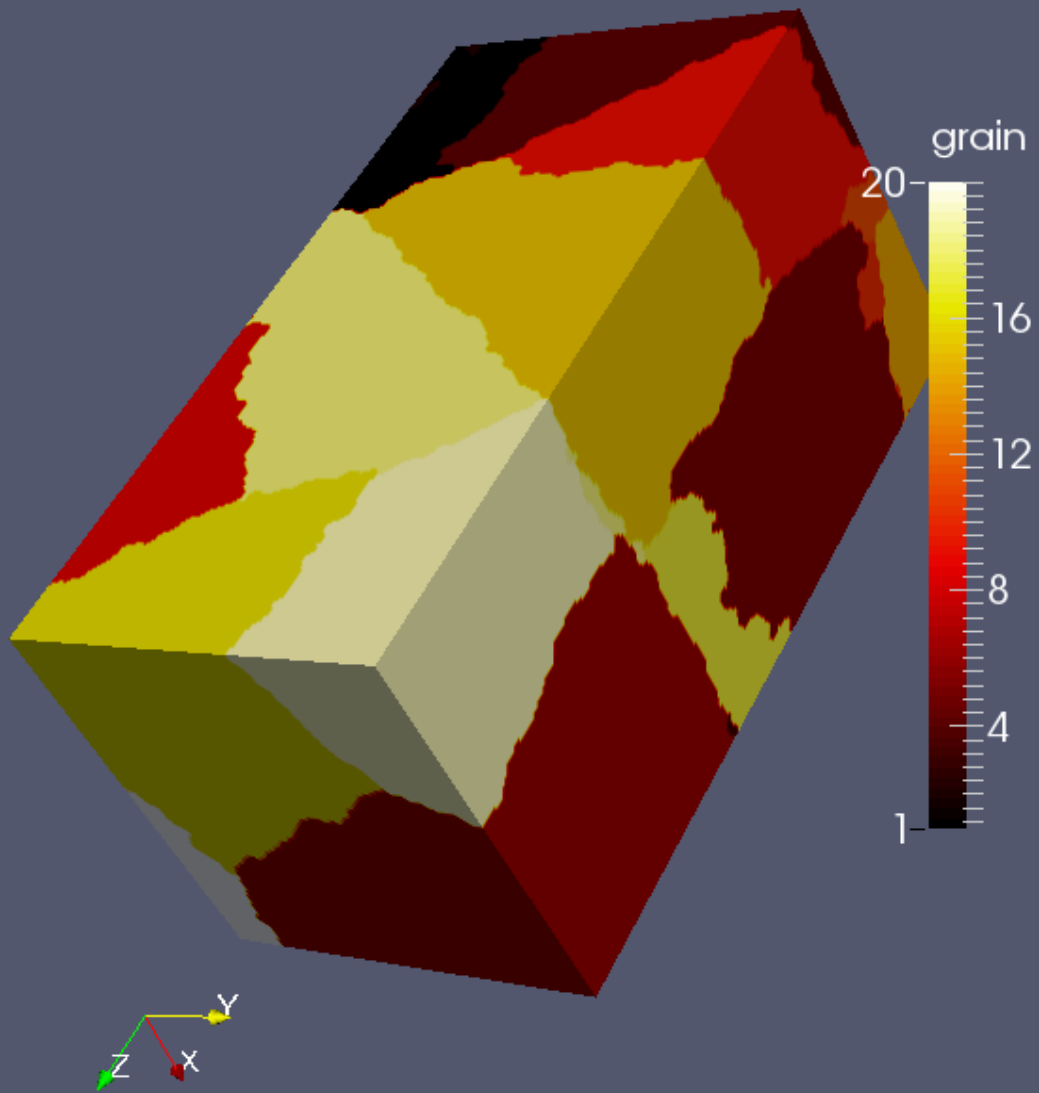
Meso-scale models

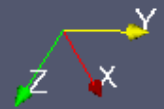
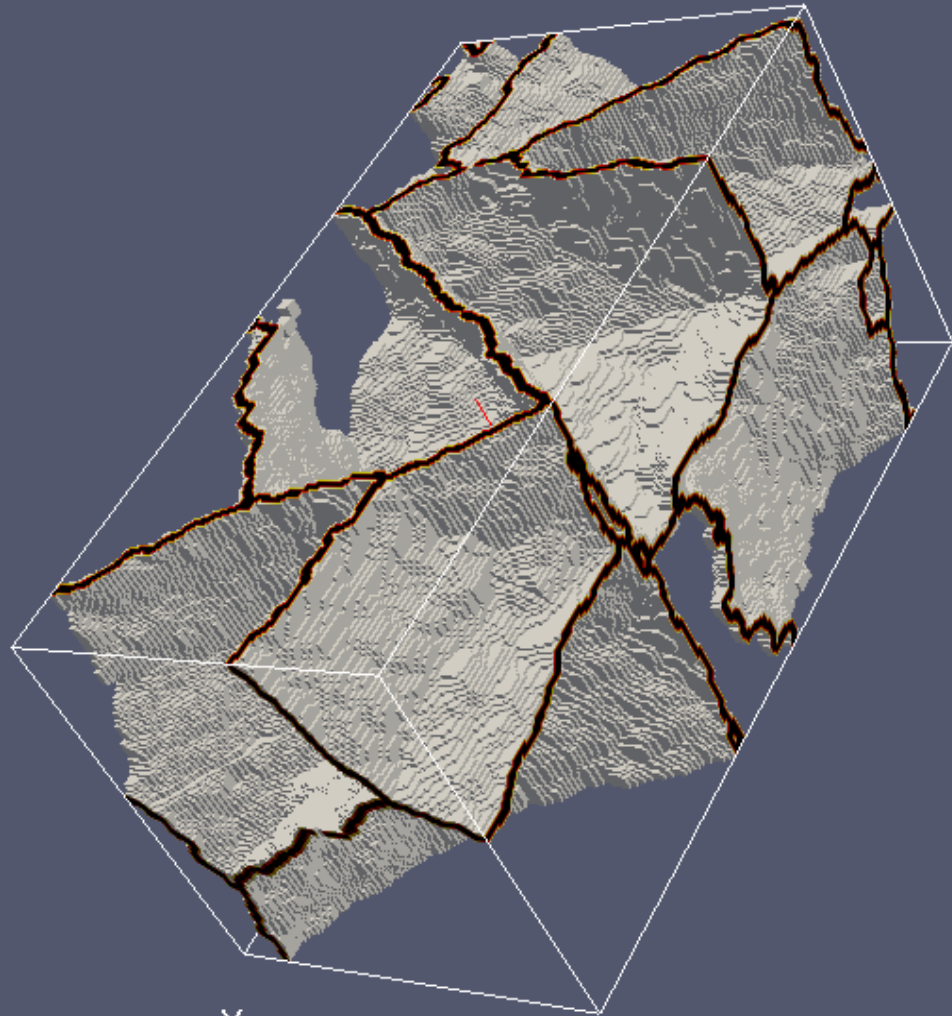
- Lattice-based or cellular automata ...
- Simulate mechanisms at grain scale
- Emergent behaviour such as fatigue/fracture
- Iterative 2-level process
 - Meso-scale updates FE scale continuum properties
 - FE computes new stresses

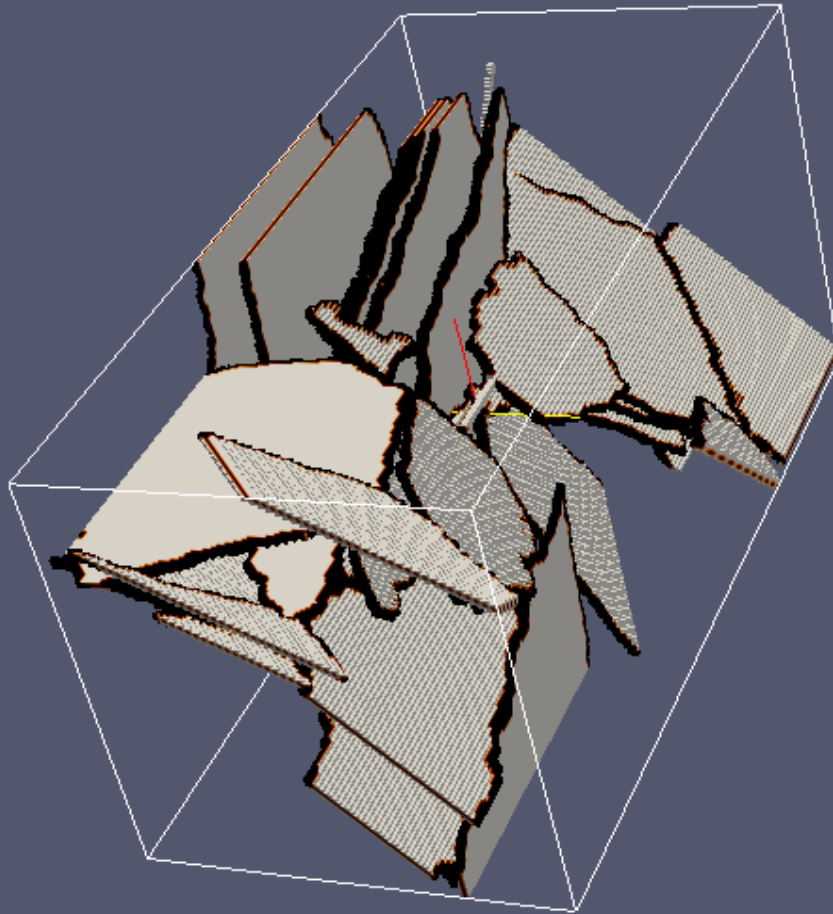
Cellular automata



Shterenlikht A. and Howard I.C. (2006) "The CAFE model of fracture – application to a TMCR steel", Fatigue and Fracture of Engineering Materials and Structures, Volume 29, Issue 9-10







Multiphysics

ALSTOM

EPSRC CASE PhD Studentship

Couple OpenFOAM + ParaFEM

Fluid-structure interaction in wind farms



MANCHESTER
1824

The University of Manchester
Aerospace Research Institute

PhD Student in cohesive fracture
Modelling damage in CFC
Abaqus UEL interface in ParaFEM



Other Activities



THE UNIVERSITY
of EDINBURGH



Nonlinear geometry with plasticity
Abaqus UMAT interface

User Upgrade Program
Available TODAY

Intel® Xeon Phi™ Product Family

Industry and User Momentum

1 TFLOPS¹

Knights Corner



[Intel® Xeon Phi™ Coprocessor – Applications and Solutions Catalog](#)

3+ TFLOPS²

- Bootable Processor
- On-Pkg, High BW Memory
- Integrated Fabric

Knights Landing

2H'15
First
Commercial
Systems



+



>50 systems providers expected³

many more card-based systems

>100 PFLOPS customer system compute commits to-date³

Announcing

Knights Hill

3rd Generation Intel® Xeon Phi™ Product Family

2nd Generation Intel Omni-Path Architecture

10nm process technology

¹Claim based on calculated theoretical peak double precision performance capability for a single coprocessor. 16 DP FLOPS/clock/core * 61 cores * 1.23GHz = 1.208 TeraFLOPS
²Over 3 Teraflops of peak theoretical double-precision performance is preliminary and based on current expectations of cores, clock frequency and floating point operations per cycle. FLOPS = cores x clock frequency x floating-point operations per second per cycle. ³Intel internal estimate





Tianhe-2

33.86 Petaflops

3,120,000 cores (Intel Ivy Bridge and Xeon Phi)
33,860,000,000,000,000 floating point operations per second

Summary

ParaFEM Open Source Library

Solvers

Maths libraries

MPI

OpenMP

GPUs

Xeon Phi

ARM

Cloud



Random field generator

OpenFOAM FSI

ParaView Viz

Cellular Automata



ParaFEM Open Source Library

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ARM

Cloud



ABAQUS UMAT/UEL

ENSIGHT



Summary

- Aiming to build the next generation platform for engineering simulation ~2018-2020
- Software engineering focus on “plug and play” interfaces between OSS/proprietary code
- No need to reinvent the wheel
- Development work is research-driven
- Strong interest from industry, USA and China